

#10/A Gp #2826  
2/3/03  
Muller



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:  
AMMAR

Serial No. 09/863,030

Filing Date: May 22, 2001

Confirmation No. 7280

For: THICK FILM MILLIMETER WAVE  
TRANSCEIVER MODULE

Examiner: J. Mondt

Art Unit: 2826

TECHNOLOGY CENTER 2800

JAN 29 2003

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AMENDMENT

Director, U.S. Patent and Trademark Office  
Washington, DC 20231

Sir:

Responsive to the Official Action of October 24,  
2002, please enter the amendments and remarks set out below.

In the Claims:

Please amend Claims 1, 10, 16 and 26 as follows:

A<sup>1</sup>

1. (ONCE AMENDED) A thick film millimeter wave  
transceiver module comprising:  
base plate;  
a multi-layer, thick film substrate board, formed  
from a plurality of layers of low temperature co-fired ceramic  
material and received on said base plate and MMIC chips  
directly attached to the substrate board, said layers  
comprising at least one of